



#### 2.0A SCHOTTKY BARRIER RECTIFIER

#### Product Summary (@T<sub>A</sub> = +25°C)

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F(MAX)</sub> (V)	Ι <sub>R(MAX)</sub> (μΑ)	
60	2	0.76	0.3	

## **Description and Applications**

The SDM2M60S1F is a single rectifier packaged in SOD123F (Standard), offering very low forward voltage drop ( $V_F$ ) and excellent low reverse leakage stability at high temperatures.

- DC-DC Converter
- AC-DC Rectifier
- Reverse Polarity Protection
- SMPS

#### **Features and Benefits**

- Superior Reverse Avalanche Capability
- Patented Interlocking Clip Design for High Surge Current Capacity
- Soft, Fast Switching Capability
- +175°C Operation Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SOD123F (Standard)
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 3
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

SOD123F (Standard)

### Ordering Information (Note 4)

Part Number	Case	Packaging
SDM2M60S1F-7	SOD123F (Standard)	3000/Tape & Reel

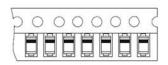
Top View

- Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  - 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  - 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



 $E_{\underline{6}}$  = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 2 = February)



Date Code	Key											
Year		2015	2016	20	017	2018	201	9	2020	2021		2022
Code		С	D		E	F	G		Н			J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub>	60	V
Average Rectified Output Current	lo	2	А
Non-Repetitive Peak Forward Surge Current 8.3mS	I <sub>FSM</sub>	60	A

# **Thermal Characteristics**

Symbol	Value	Unit
R <sub>0JA</sub>	70	°C/W
R <sub>θJC</sub>	20	°C/W
T <sub>J,</sub> T <sub>STG</sub>	-65 to +175	°C
	R <sub>0JA</sub> R <sub>0JC</sub>	R <sub>θJA</sub> 70        R <sub>θJC</sub> 20

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

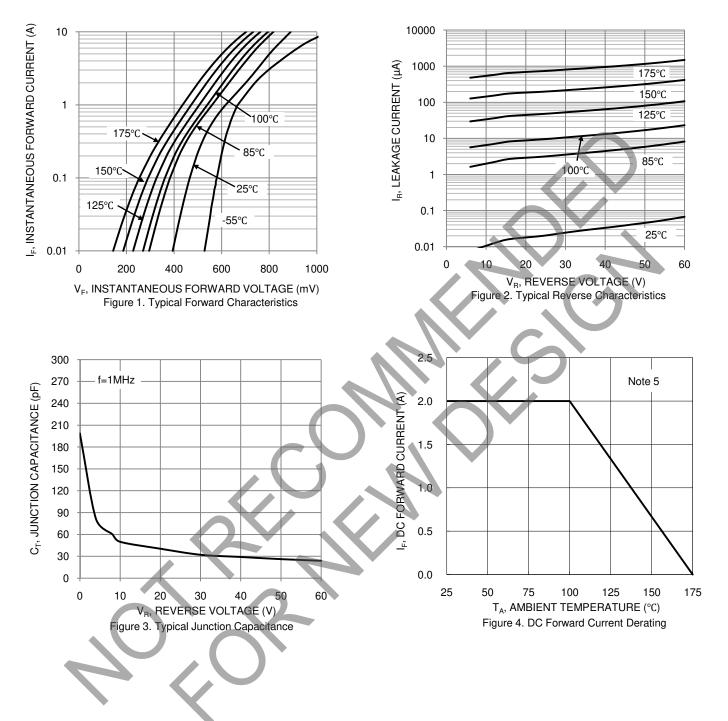
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	M		0.62	0.66		$I_F = 1A, T_J = +25^{\circ}C$
Forward Voltage Drop	V <sub>F</sub>	-	0.70	0.76	v	$I_F = 2A, T_J = +25^{\circ}C$
Leakage Current (Note 6)	I-		0.07	0.3	μΑ	$V_R = 60V, T_J = +25^{\circ}C$
Leakage Current (Note 0)	IR	—	110	—	μΑ	$V_R = 60V, T_J = +125^{\circ}C$
Junction Capacitance	CJ	_)	80		pF	$V_R = 4V, T_J = +25^{\circ}C$

 Device mounted on FR-4 substrate, 0.4"\*0.5", 2oz, single-sided, PC boards with 0.2"\*0.25" copper pad.
 Short duration pulse test used to minimize self-heating effect. Notes:



### NOT RECOMMENDED FOR NEW DESIGN USE <u>SBR2M60S1F</u>

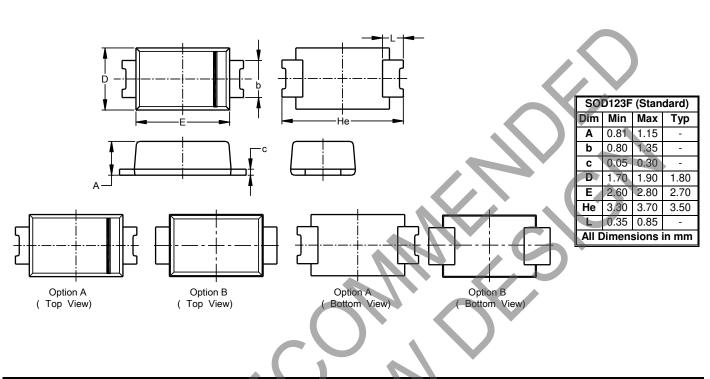
## SDM2M60S1F





# Package Outline Dimensions

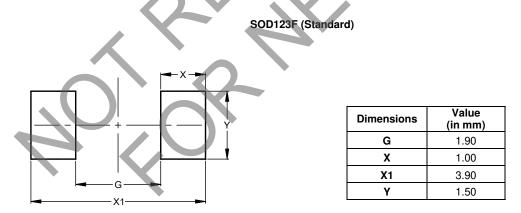
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOD123F (Standard)

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





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